

MOSFET

Metal Oxide Semiconductor Field Effect Transistor

CoolMOS C6

600V CoolMOS™ C6 Power Transistor IPW60R041C6

Data Sheet

Rev. 2.1, 2010-07-12

Final

Industrial & Multimarket

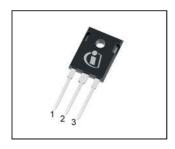


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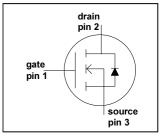
1 Description

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ C6 series combines the experience of the leading SJ MOSFET supplier with high class innovation. The offered devices provide all benefits of a fast switching SJ MOSFET while not sacrificing ease of use. Extremely low switching and conduction losses make switching applications even more efficient, more compact, lighter, and cooler.



Features

- Extremely low losses due to very low FOM Rdson*Qg and Eoss
- · Very high commutation ruggedness
- · Easy to use/drive
- JEDEC1) qualified, Pb-free plating, Halogen free



Applications

PFC stages, hard switching PWM stages and resonant switching PWM stages for e.g. PC Silverbox, Adapter, LCD & PDP TV, Lighting, Server, Telecom and UPS.



Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.





Table 1 Key Performance Parameters

Parameter	Value	Unit	
$V_{\rm DS}$ @ $T_{\rm j,max}$	650	V	
$R_{ extsf{DS(on)}, extsf{max}}$	0.041	Ω	
$Q_{\sf g,typ}$	290	nC	
$I_{D,pulse}$	272	А	
E _{oss} @ 400V	22	μJ	
Body diode di/dt	300	A/µs	

Related Links	
IFX C6 Product Brief	
IFX C6 Portfolio	
IFX CoolMOS Webpage	
IFX Design tools	

Туре	Package	Marking
IPW60R041C6	PG-TO247	6R041C6

¹⁾ J-STD20 and JESD22



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Maximum ratings

2 Maximum ratings

at T_i = 25 °C, unless otherwise specified.

Table 2 Maximum ratings

Parameter	Symbol		Valu	ies	Unit	Note / Test Condition	
		Min.	Тур.	Max.			
Continuous drain current ¹⁾	I_{D}	-	-	77.5	Α	T _C = 25 °C	
				49		T _C = 100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	272	Α	T _C =25 °C	
Avalanche energy, single pulse	E _{AS}	-	-	1954	mJ	I _D =13.4 A, V _{DD} =50 V (see table 17)	
Avalanche energy, repetitive	E _{AR}	-	-	2.96		I _D =13.4 A, V _{DD} =50 V	
Avalanche current, repetitive	I _{AR}	-	-	13.4	Α		
MOSFET dv/dt ruggedness	dv/dt	-	-	50	V/ns	V _{DS} =0480 V	
Gate source voltage	V_{GS}	-20	-	20	V	static	
		-30		30		AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	481	W	T _C =25 °C	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	150	°C		
Mounting torque		-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	67.2	Α	T _C =25 °C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	272	Α	T _C =25 °C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	15	V/ns	$V_{\rm DS}$ =0400 V, $I_{\rm SD} \le I_{\rm D}$, $T_{\rm j}$ =25 °C	
Maximum diode commutation speed ³⁾	di _f /dt	-	-	300	A/µs	(see table 18)	

¹⁾ Limited by $T_{\rm j,max}$ Maximum duty cycle D=0.75

3 Thermal characteristics

Table 3 Thermal characteristics TO-247

Parameter	Symbol Values				Unit	Note /
		Min.	Тур.	Max.		Test Condition
Thermal resistance, junction - case	R_{thJC}	-	-	0.26	°C/W	
Thermal resistance, junction - ambient	R_{thJA}	-	-	62		leaded
Soldering temperature, wavesoldering only allowed at leads	$T_{ m sold}$	-	-	260	°C	1.6 mm (0.063 in.) from case for 10 s

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²⁾ Pulse width t_p limited by $T_{j,max}$

³⁾ Identical low side and high side switch with identical $R_{\rm G}$

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Electrical characteristics

Electrical characteristics 4

Electrical characteristics, at Tj=25 °C, unless otherwise specified.

Table 4 **Static characteristics**

Parameter	Symbol		Values	;	Unit	Note / Test Condition
		Min.	Тур.	Max.		
Drain-source breakdown voltage	$V_{(\mathrm{BR})\mathrm{DSS}}$	600	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =0.25 mA
Gate threshold voltage	$V_{GS(th)}$	2.5	3	3.5		$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 2.96 \text{ mA}$
Zero gate voltage drain current	I_{DSS}	-	-	5	μА	$V_{\rm DS}$ =600 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C
		-	50	-		$V_{\rm DS}$ =600 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =150 °C
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance	$R_{DS(on)}$	-	0.037	0.041	Ω	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =44.4 A, $T_{\rm j}$ =25 °C
		-	0.096	-		$V_{\rm GS}$ =10 V, $I_{\rm D}$ =44.4 A, $T_{\rm j}$ =150 °C
Gate resistance	R_{G}	-	0.7	-	Ω	f=1 MHz, open drain

Table 5 **Dynamic characteristics**

Parameter	Symbol		Value	Values		Note /
		Min.	Тур.	Max.		Test Condition
Input capacitance	C_{iss}	-	6530	-	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =100 V,
Output capacitance	C_{oss}	-	360	-		<i>f</i> =1 MHz
Effective output capacitance, energy related ¹⁾	$C_{o(er)}$	-	235	-		$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =0480 V
Effective output capacitance, time related ²⁾	$C_{o(tr)}$	-	1210	-		$I_{\rm D}$ =constant, $V_{\rm GS}$ =0 V $V_{\rm DS}$ =0480V
Turn-on delay time	$t_{\rm d(on)}$	-	23	-	ns	V _{DD} =400 V,
Rise time	t_{r}	-	10	-		$V_{\rm GS}$ =13 V, $I_{\rm D}$ =44.4A,
Turn-off delay time	$t_{\sf d(off)}$	-	130	-		$R_{\rm G}$ = 1.7 Ω (see table 16)
Fall time	t_{f}	-	7	-		(SCC table 10)

¹⁾ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{\text{(BR)DSS}}$ 2) $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{\text{(BR)DSS}}$

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Electrical characteristics

Table 6 Gate charge characteristics

Parameter	Symbol	Symbol Values				Note /
		Min.	Тур.	Max.		Test Condition
Gate to source charge	$Q_{\sf gs}$	-	36	-	nC	V _{DD} =480 V,
Gate to drain charge	$Q_{\sf gd}$	-	150	-		I _D =44.4 A,
Gate charge total	Q_{g}	-	290	-		$V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	5.4	-	V	

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Diode forward voltage	V_{SD}	-	0.9	-	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =44.4 A, $T_{\rm j}$ =25 °C
Reverse recovery time	t _{rr}	-	950	-	ns	$V_{\rm R}$ =400 V, $I_{\rm F}$ =44.4 A,
Reverse recovery charge	Q_{rr}	-	32	-	μC	d <i>i</i> _F /d <i>t</i> =100 A/μs (see table 18)
Peak reverse recovery current	I_{rrm}	-	62	-	Α	

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5 Electrical characteristics diagrams

Table 8

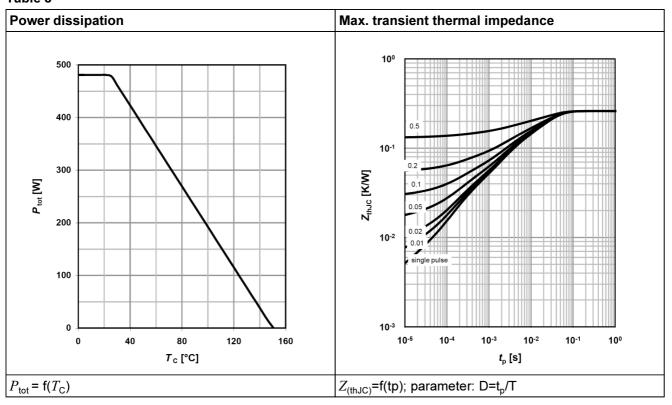
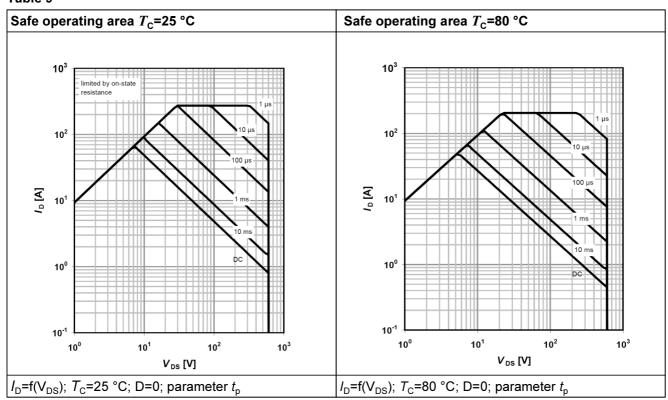


Table 9



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Table 10

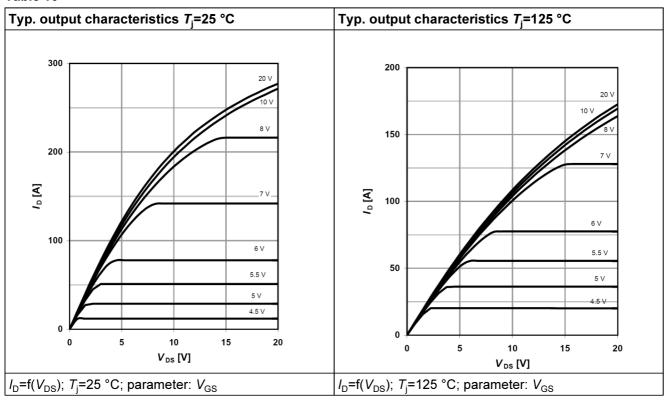
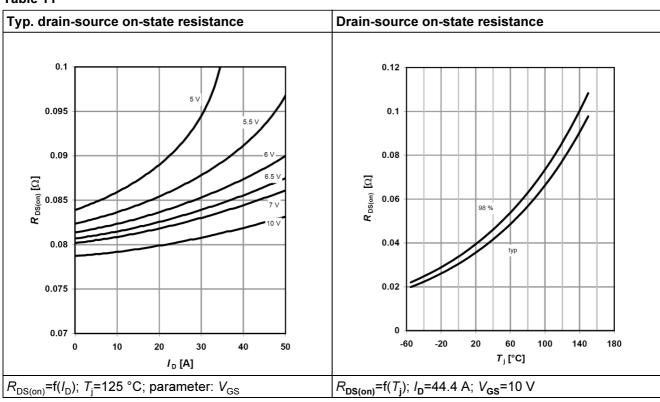


Table 11



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Table 12

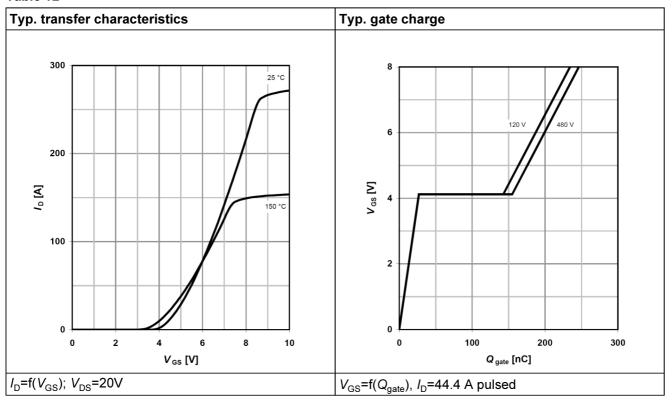
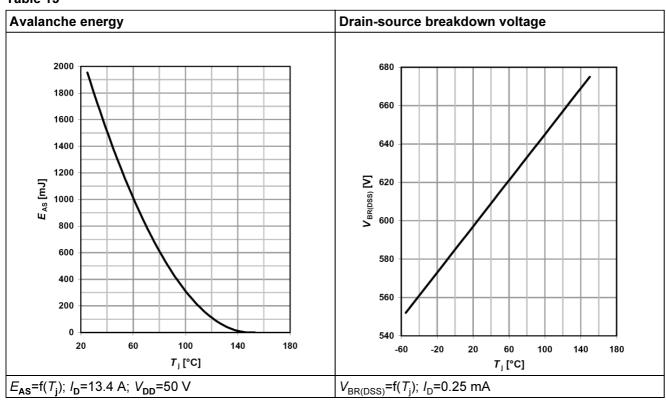


Table 13



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Table 14

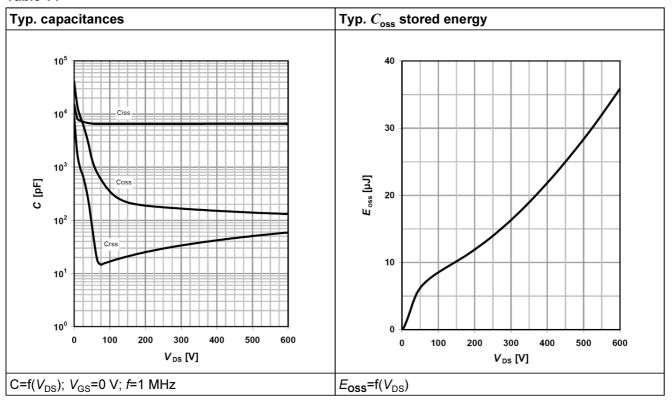
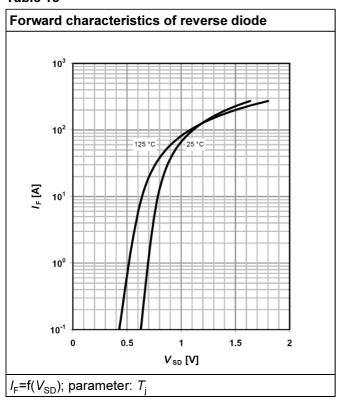


Table 15



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Test circuits

6 Test circuits

Table 16 Switching times test circuit and waveform for inductive load

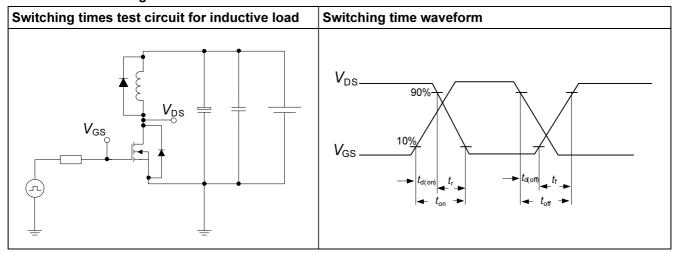


Table 17 Unclamped inductive load test circuit and waveform

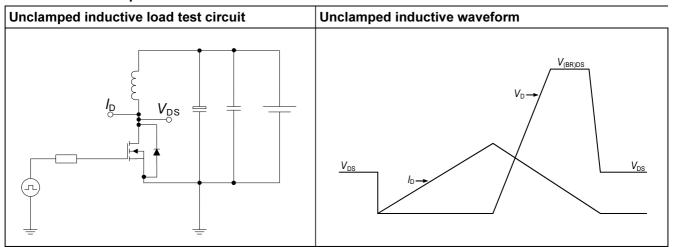
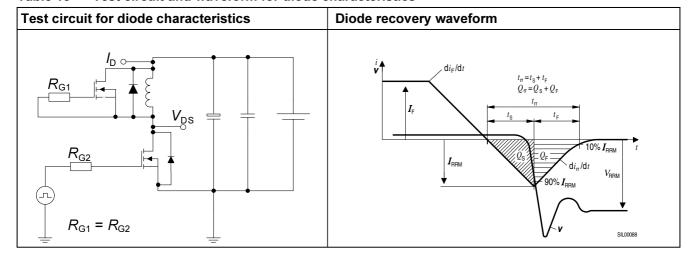


Table 18 Test circuit and waveform for diode characteristics



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Package outlines

7 Package outlines

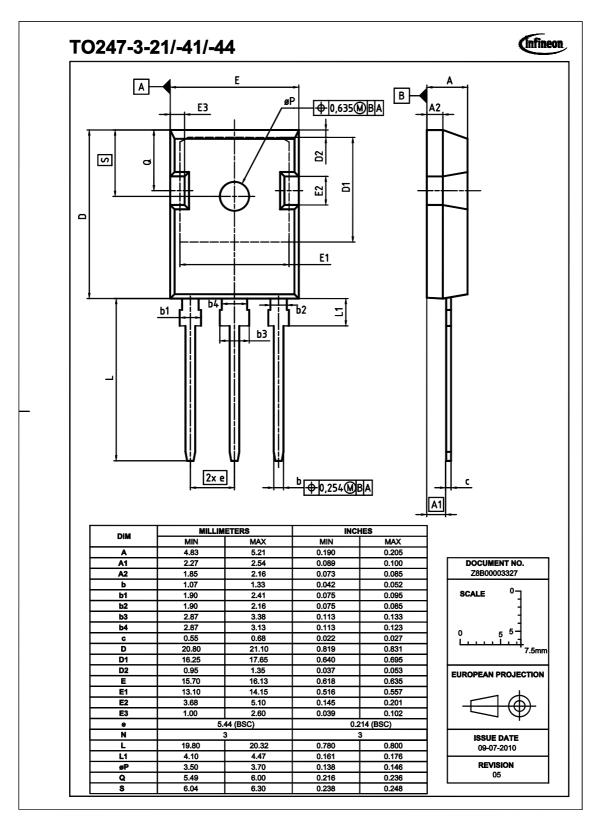


Figure 1 Outlines TO-247, dimensions in mm/inches

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Revision History

8	Revision History

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